

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5793870

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	KYLE K. KIRBY	10/30/2017
RECEIVING PARTY DATA		
Name:	MICRON TECHNOLOGY, INC.	
Street Address:	8000 S. FEDERAL WAY	
City:	BOISE	
State/Country:	IDAHO	
Postal Code:	83716	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	16667360
CORRESPONDENCE DATA		
Fax Number:	(208)562-4901	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	2085624900	
Email:	instructions@parsonsbehle.com	
Correspondent Name:	PARSONS BEHLE & LATIMER - MICRON MICRON	
Address Line 1:	800 W. MAIN STREET	
Address Line 2:	SUITE 1300	
Address Line 4:	BOISE, IDAHO 83702	
ATTORNEY DOCKET NUMBER:	05847.049US02	
NAME OF SUBMITTER:	JAMES D. MEADERS	
SIGNATURE:	/James D. Meaders/	
DATE SIGNED:	10/29/2019	
Total Attachments: 2		
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PATENT APPLICATION ASSIGNMENT

WHEREAS, I, **Kyle K. Kirby**, residing in Eagle, Idaho, USA has invented new and useful improvements in 3DI Solder Cup for which Assignor is making or has made application for LETTERS PATENT OF THE UNITED STATES, which application has been duly executed by Assignor concurrently herewith;

WHEREAS, Micron Technology, Inc., a corporation organized and existing under and by virtue of the laws of the State of Delaware, and having an office and place of business at 8000 S. Federal Way, Boise, Idaho 83716 USA, (hereinafter "Assignee") is desirous of acquiring our entire right, title and interest in said application and our Letters Patent which may issue thereon.

NOW, THEREFORE, it be known by all whom it may concern that for and in consideration of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and other good and valuable consideration, I hereby assign to said corporation, both in and for the territory of the United States of America and the entire world, all our title and interest in and to said invention, patent application and any patent which may issue thereon, including all divisions, continuations, reissues, continuations-in-part and substitutions thereof, plus all priority rights for patent applications foreign to the United States of America. I further hereby assign and transfer to said corporation whatever cause of action I may have for past or present infringement of said invention, together with the right to bring suit for any such infringement and to seek and receive damages and other relief arising from any such infringement.

I HEREBY covenant and agree that I will at any time, upon the request of said corporation, execute and deliver any and all papers and do all lawful acts that may be necessary or desirable to perfect the title to said invention, applications and patents, and I authorize the Commissioner of Patents and Trademarks to issue Letters patent to said corporation.

Inventor 1

Kyle K. Kirby
KYLE K. KIRBY

Date: 10/30/17

STATE OF

SS.

COUNTY OF

This 30th day of October, 2017 before me personally came the above-named, Kyle K. Kirby, to me personally known as the individual who executed the foregoing assignment, who acknowledged to me that he/she executed the same of his/her own free will for the purposes therein set forth.

Seal



Diane V. Rangel
(Notary Public)